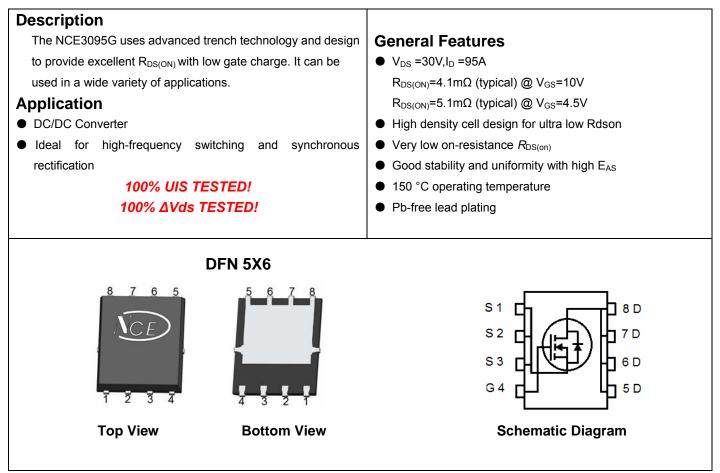


## NCE N-Channel Enhancement Mode Power MOSFET



#### **Package Marking and Ordering Information**

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE3095G	NCE3095G	DFN 5x6-8L	-	-	-

#### Absolute Maximum Ratings (T<sub>c</sub>=25<sup>°</sup>C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	Vds	30	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	Ι <sub>D</sub>	95	А
Drain Current-Continuous(T <sub>C</sub> =100℃)	I <sub>D</sub> (100℃)	63.6	A
Pulsed Drain Current	I <sub>DM</sub>	300	A
Maximum Power Dissipation	PD	80	W
Derating factor		0.64	W/℃
Single pulse avalanche energy (Note 5)	E <sub>AS</sub>	150	mJ
Operating Junction and Storage Temperature Range	T <sub>J</sub> ,T <sub>STG</sub>	-55 To 150	°C
Thermal Characteristic			
Thermal Resistance, Junction-to-Case <sup>(Note 2)</sup>	R <sub>eJC</sub>	1.56	°C/W



### Electrical Characteristics (TC=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics	ŀ					
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250µA	30	-	-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =30V,V <sub>GS</sub> =0V	-	-	1	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V	-	-	±100	nA
On Characteristics (Note 3)		·				
Gate Threshold Voltage	$V_{GS(th)}$	V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =250µA	1	1.5	2.5	V
Drain-Source On-State Resistance		V <sub>GS</sub> =10V, I <sub>D</sub> =20A	-	4.1	5.1	mΩ
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =4.5V, I <sub>D</sub> =20A	-	5.5	8.5	
Forward Transconductance	<b>g</b> fs	V <sub>DS</sub> =5V,I <sub>D</sub> =20A	30	-	-	S
Dynamic Characteristics (Note4)	ŀ					
Input Capacitance	C <sub>lss</sub>	- V <sub>DS</sub> =15V,V <sub>GS</sub> =0V, F=1.0MHz	-	1784	-	PF
Output Capacitance	C <sub>oss</sub>		-	266	-	PF
Reverse Transfer Capacitance	C <sub>rss</sub>		-	212	-	PF
Switching Characteristics (Note 4)		·				
Turn-on Delay Time	t <sub>d(on)</sub>	$V_{DD}$ =5V, $I_D$ =20A $V_{GS}$ =10V, $R_{GEN}$ =6 $\Omega$	-	7	-	nS
Turn-on Rise Time	tr		-	6	-	nS
Turn-Off Delay Time	t <sub>d(off)</sub>		-	30	-	nS
Turn-Off Fall Time	t <sub>f</sub>		-	8	-	nS
Total Gate Charge	Qg		-	38.4	-	nC
Gate-Source Charge	Q <sub>gs</sub>	V <sub>DS</sub> =15V,I <sub>D</sub> =20A, V <sub>GS</sub> =10V	-	5.8	-	nC
Gate-Drain Charge	Q <sub>gd</sub>	V <sub>GS</sub> -10V	-	7.9	-	nC
Drain-Source Diode Characteristics		·				
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =20A	-	0.85	1.2	V
Diode Forward Current (Note 2)	I <sub>S</sub>		-	-	95	А
Reverse Recovery Time	t <sub>rr</sub>	TJ = 25°C, I <sub>F</sub> = 20A	-	-	47	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs <sup>(Note3)</sup>	-	-	25	nC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)			y LS+LD)	

#### Notes:

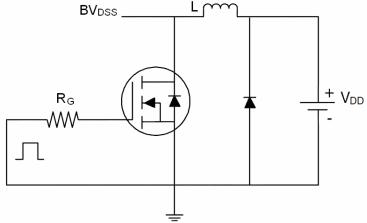
- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board,  $t \le 10$  sec.
- **3.** Pulse Test: Pulse Width  $\leq$  300µs, Duty Cycle  $\leq$  2%.
- 4. Guaranteed by design, not subject to production
- **5.** EAS condition: Tj=25  $^{\circ}$ C,V<sub>DD</sub>=15V,V<sub>G</sub>=10V,L=0.1mH,Rg=25 $\Omega$



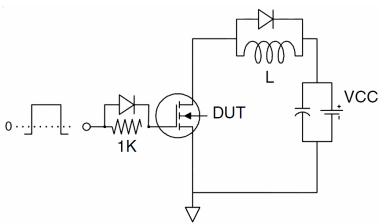
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## Test Circuit

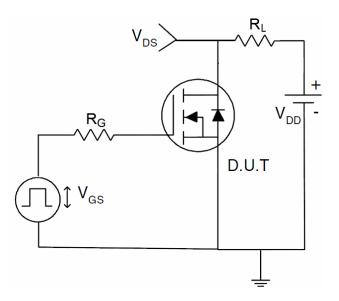
1) E<sub>AS</sub> Test Circuits



2) Gate Charge Test Circuit

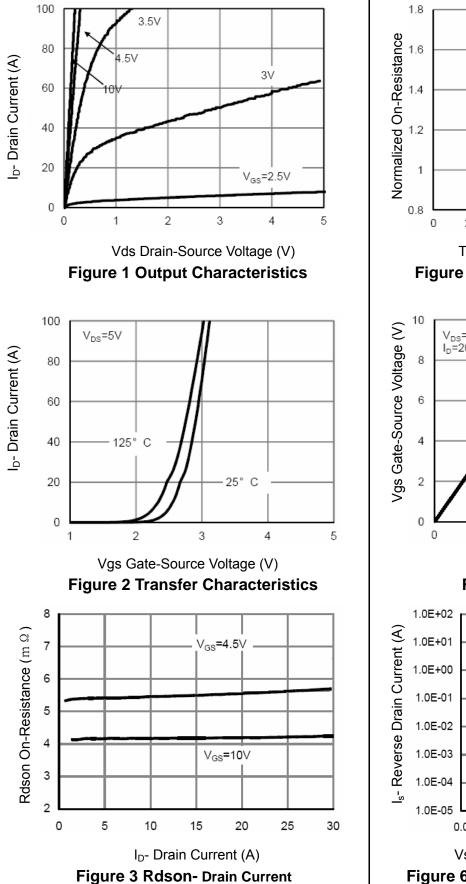


3) Switch Time Test Circuit





## **Typical Electrical and Thermal Characteristics (Curves)**



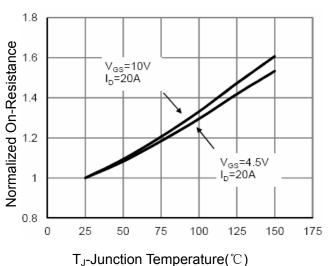
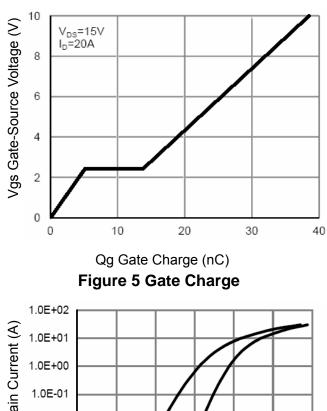


Figure 4 Rdson-Junction Temperature



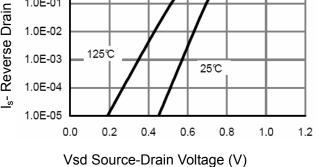
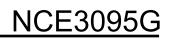
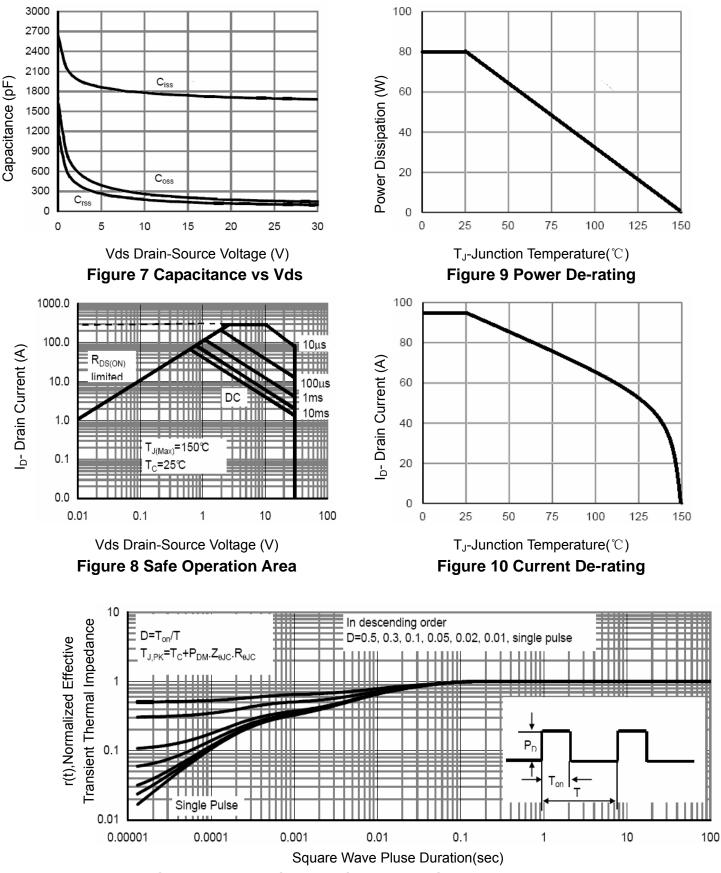


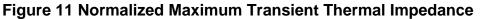
Figure 6 Source- Drain Diode Forward



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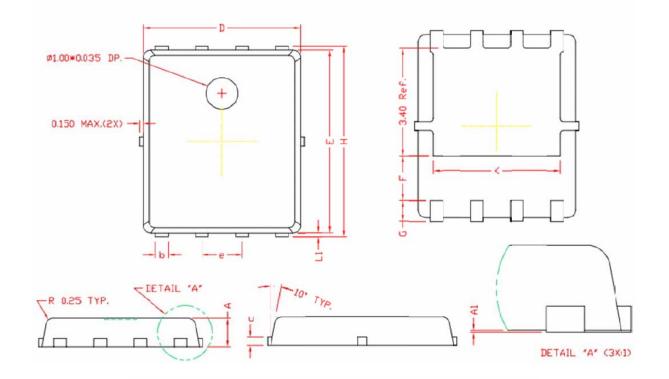






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## DFN5X6-8L Package Information



# COMMON DIMENSIONS

# (UNITS OF MEASURE=MILLIMETER)

SYMBOL	MIN	NOM	MAX	
A	0.80	0.90	1.00	
A1	0.00	0.03	0.05	
b	0.35	0.42	0.49	
С	0.254 REF.			
D	4.90	5.00	5.10	
F	1.40 REF.			
E	5.70	5.80	5.90	
е	1.27 BSC.			
Н	5.95	6.08	6.20	
L1	0.10	0.14	0.18	
G	0.60 REF.			
К	4.00 REF.			



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